APPLICAE	BLE STANI	DARD							
	Operating				Storage		40.00 4 00.04	.	
	Temperature Range		-55 °C to 85 °C (1)		Temperature Range		-10 °C to 60 °C		
Rating	Voltage		50 V AC		Storage Hu	midity Range	Relative humidity 85	% max	,
					Operating F	lumidity Range	(Not dewed)		•
				·ICIC A T					
				IFICAT	IONS				T
	EM		TEST METHOD			REQUI	IREMENTS	QT	AT
CONSTRU	JCTION								
General Exam	nination	Visually a	and by measuring instrument		Accord	ing to drawing		×	×
Marking		Confirme	d visually.					×	×
ELECTRIC	CHARAC	TERISTI	CS						
Contact Resistance		100 mA(DC or 1000Hz)			70m	70mΩ MAX.			_
Insulation Resistance		100 V DC.			1001	100 M Ω MIN.			_
Voltage Proof		150 V AC for 1 min.			No flas	No flashover or breakdown.			×
MECHANIC	CAL CHAR	ACTERI	STICS						
Insertion and		Measure	d by applicable connector.		Insertic	n Force:	42.5 N MAX.	×	_
Withdrawal Forces						Withdrawal Force: 4.25 N MIN.			
Mechanical Operation		50 times insertions and extractions.			-	① Contact Resistance : 80m Ω MAX.			-
N. (1)		F				② No damage, crack and looseness of parts.			
Vibration		Frequency 10 to 55 to 10Hz, approx 5min				 No electrical discontinuity of 1 μs. No damage, crack and looseness of parts. 			-
		Single amplitude : 0.75 mm, 10 cycles for 3 axial directions.			(2) No				
Shock		490 m/s ² , duration of pulse 11 ms							+_
CHOOK		at 3 times for 3 both axial directions.							
EN//IRONI	MENTALO		TERISTICS		l			1	1
Damp Heat	WILINIAL O			96 h	① Cor	tact Desistant	ra : 80m O MAY	Τ×	Τ_
(Steady state)		Exposed at 40±2 °C, 90 ~ 95 %, 96 h.			"	① Contact Resistance : 80m Ω MAX. ② Insulation Resistance:100 MΩ MIN.			
Rapid Change of		Temperat	ure -55 → +85 °C			No damage, crack and looseness of parts.			+_
Temperature		Time $30 \rightarrow 30$ min.				aamago, orao.	tana loodonlood of parts.	×	
		under 5							
		1	n time to chamber : within 2~3	MIN)					
Cold		Exposed at -55°C, 96 h			① Cor	ntact Resistand	ce : 80mΩ	×	-
					② No	damage, cracl	and looseness of parts.		
Dry Heat	Dry Heat		at 85°C, 96 h			-			+-
J., 11001		LAPOSCU	at 00 0, 00 11					×	
Sulfur Dioxide			105 : 0°0 75 : 50/DH 05 5	D14 (00		No defect such as corrosion which impairs			
		Exposed at 25±2°C, 75±5%RH, 25 PPM for 96 h. (Test standard: JIS C 60068)			I			×	-
					I _	the function of connector. ② Contact Resistance : 80m Ω			
Resistance to		1)Reflow soldering :				No deformation of case of excessive looseness			+-
Soldering Heat Solderability		Peak TMP : 260°CMAX Reflow TMP: 220°CMIN for 60sec			l l	erminal.		×	
		2) Soldering irons: 360°C MAX. for 5 sec.							
		Soldered at solder temperature			I	A new uniform coating of solder shall cover a			-
· 		245±3℃	for immersion duration, 3 se	ec.	minimu	minimum of 95 % of the surface being			
		,			immers	immersed.			
								1	
								1	
								1	
1 001111	T	ECODIDE:	ON OF BEVIOLONG	Τ.		T	CHECKED	<u> </u>	
COUN	- DI	ESCRIPTI	ON OF REVISIONS		DESIGNED		CHECKED	DA	\TE
<u> </u>									
		iture rise caused by current-carrying. eans a long-term storage state for the unused product y to PCB.				APPROVED HS. OKAWA CHECKED KN. SHIBUYA		14.0	9. 30
								14.0	9. 30
I		, = =				DESIGNED	AH. EDASHIGE	14. 09. 30	
		E: _ d	r to JIS-C-5402.			DRAWN	AH. EDASHIGE	14. 09. 30	
Unless othe	erwise speci	riea, rerei	Note QT:Qualification Test AT:Assurance Test X:Applicable Test				PRAWING NO. ELC4-352597-		
				st	DRAWIN	IG NO	ELC4-352597	-00	
Note QT:Qu	alification Tes	t AT:Assı	urance Test X:Applicable Tes					-00	
	alification Tes	t AT:Assi		ı	DRAWIN PART NO. CODE NO.		FX22-50P-0. 5SH	<u>-00</u>	1/1